

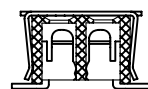
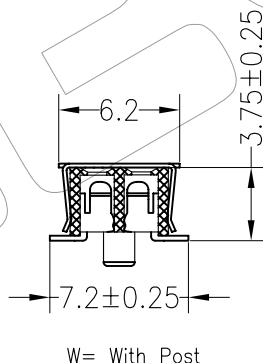
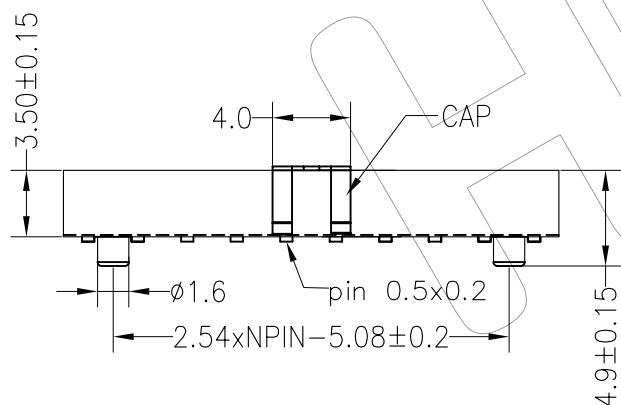
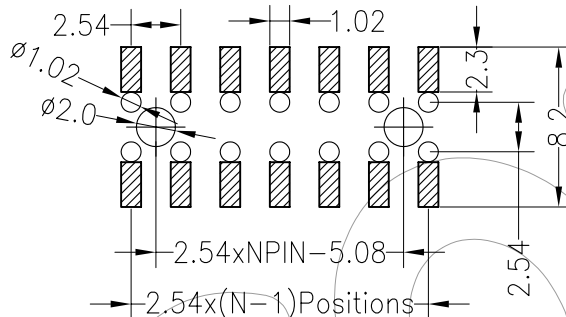
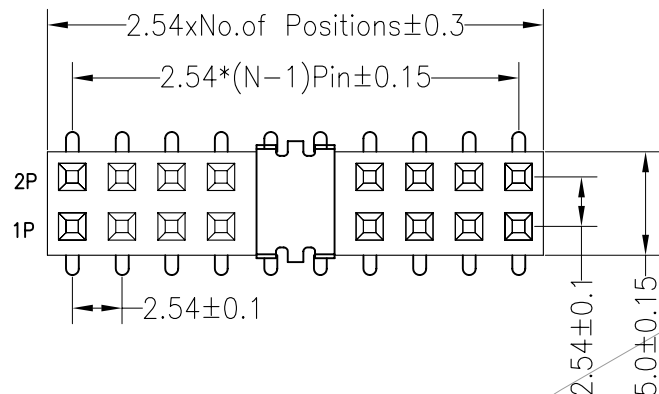
RoHS

Recommended P.C.B Layout(Top Side)
(PCB BOARD TOLERANCE ± 0.05)

SPECIFICATIONS

Rated Current:3.0AMP
Contact Resistance:20m Ω Max
Withstand Voltage:1000V AC/DC
Insulation Resistance:1000M Ω Min
Operation Temperature:-40°C to +105°C

Contact Material:Brass
Contact Plating:Au or Sn Over Ni
Insulator Material:Polyester(UL94V-0)
Standard: PA6T
Max.Processing Temp: 230°C for 30-60 seconds
(260°C for 10 seconds)



N= W/O Post

W= With Post

Ordering Information

HC-FH435 02 XX X XX M U X 01

No. of Pins Per Row 2*40
Insulator Material Option
A=BK-PBT
B=BK-PA66
C=BK-PA6T
D=BK-PA46
E=BK-PA9T
F=BK-LCP
Post
W=With Post
N=W/O Post
Contact Plating
G0:Gold Flash
G2:5U" Gold
G3:10U" Gold
G4:15U" Gold
G5:30U" Gold
S0:Gold Flash/Tin
SN:Tin
Packing
T=Tube
P=Tube+Cap
R=Reel+Cap
M=Reel+Mylar

OPERATION

X.X ± 0.30
X.XX ± 0.20
X.XXX ± 0.10
Angle $\pm 3^\circ$
DIM TOL

DRAW

Ayang

SCALE

FIT

UNIT mm

SIZE A4

SHEET 1/1

PROJ.

HECON 东莞市禾康电子有限公司
DONGGUAN HECON ELECTRONICS CO.,LTD

PART NO.

HC-FH43502XXXXXXMUX01

TITLE:

2.54mm H3.5 Dual Row SMT Female Header

A0

REV

DATE

MODIFICATION DESCRIPTION

CHANGE

DIM

TOL

PROJ.

TITLE:

2.54mm H3.5 Dual Row SMT Female Header